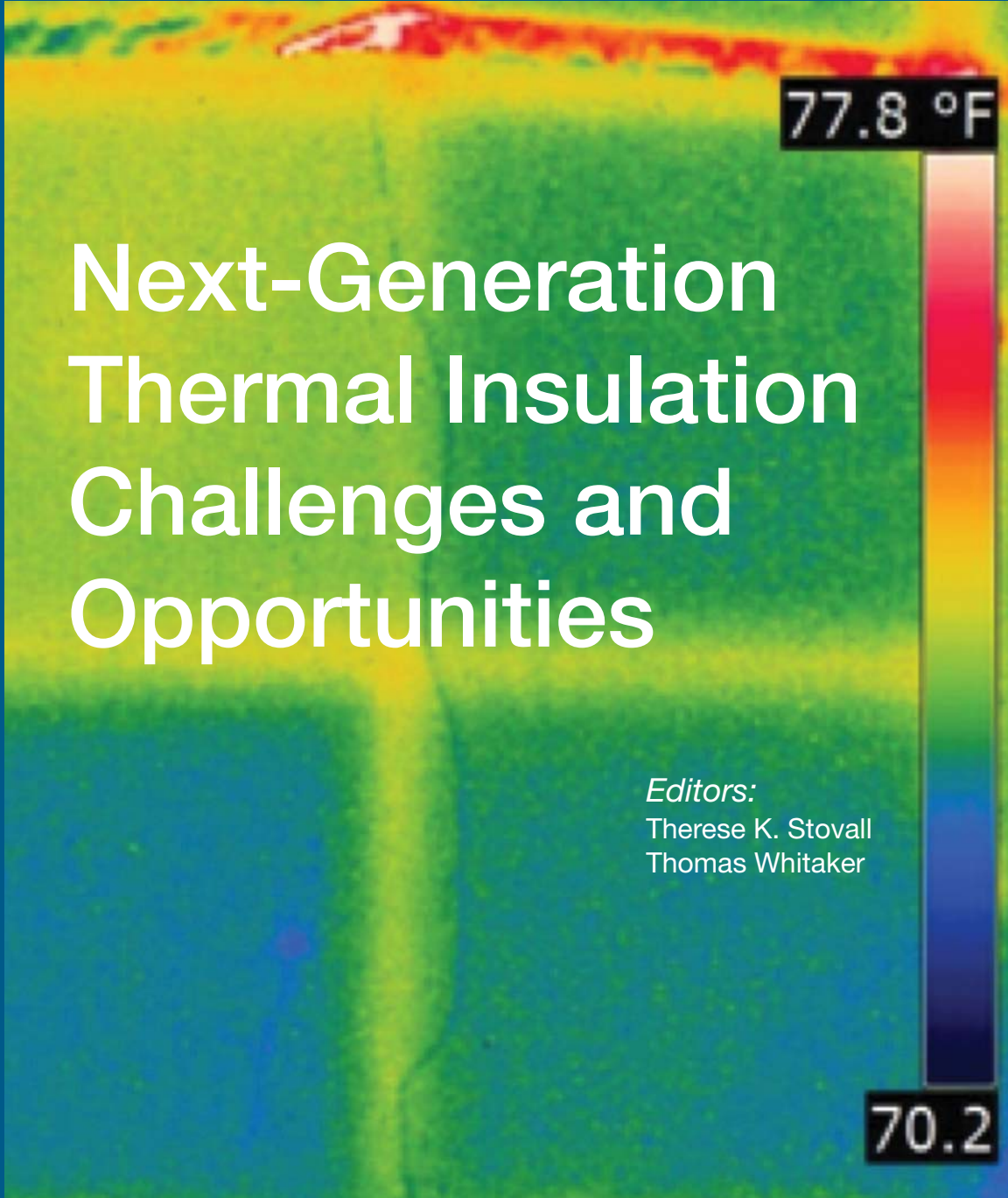


Selected Technical Papers

STP 1574



77.8 °F

Next-Generation Thermal Insulation Challenges and Opportunities

70.2

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